

NPN 6 GHz wideband transistor

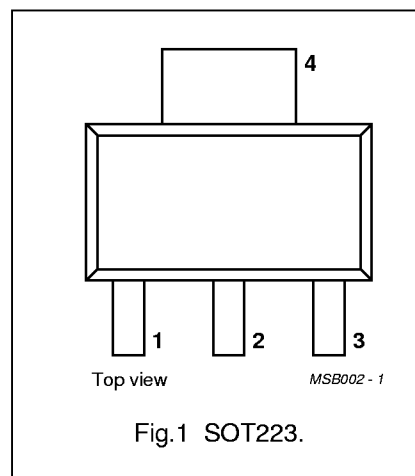
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FEATURES

- High power gain
- Low noise figure
- Low intermodulation distortion
- Gold metallization ensures excellent reliability.

PINNING

PIN	DESCRIPTION
1	emitter
2	base
3	emitter
4	collector



DESCRIPTION

NPN transistor mounted in a plastic SOT223 envelope. It is primarily intended for use in communication and instrumentation systems.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	–	15	V
V_{CEO}	collector-emitter voltage	open base	–	–	12	V
I_C	DC collector current		–	–	60	mA
P_{tot}	total power dissipation	up to $T_s = 140\text{ °C}$ (note 1)	–	–	700	mW
C_{re}	feedback capacitance	$I_C = 0$; $V_{CE} = 10\text{ V}$; $f = 1\text{ MHz}$	–	–	0.8	pF
f_T	transition frequency	$I_C = 45\text{ mA}$; $V_{CE} = 10\text{ V}$; $f = 1\text{ GHz}$; $T_{amb} = 25\text{ °C}$	4	6	–	GHz
G_{UM}	maximum unilateral power gain	$I_C = 45\text{ mA}$; $V_{CE} = 10\text{ V}$; $f = 1\text{ GHz}$; $T_{amb} = 25\text{ °C}$	11.5	13.5	–	dB
V_O	output voltage	$I_C = 45\text{ mA}$; $V_{CE} = 10\text{ V}$; $d_{im} = -60\text{ dB}$; $R_L = 75\text{ }\Omega$; $f = 800\text{ MHz}$; $T_{amb} = 25\text{ °C}$	–	500	–	mV
P_{L1}	output power at 1 dB gain compression	$I_C = 45\text{ mA}$; $V_{CE} = 10\text{ V}$; $f = 1\text{ GHz}$; $T_{amb} = 25\text{ °C}$	–	21.5	–	dBm

Note

1. T_s is the temperature at the soldering point of the collector tab.

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LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	15	V
V_{CEO}	collector-emitter voltage	open base	–	12	V
V_{EBO}	emitter-base voltage	open collector	–	2	V
I_C	DC collector current		–	60	mA
P_{tot}	total power dissipation	up to $T_s = 140\text{ °C}$ (note 1)	–	700	mW
T_{stg}	storage temperature		–65	150	°C
T_j	junction temperature		–	175	°C

THERMAL RESISTANCE

SYMBOL	PARAMETER	CONDITIONS	THERMAL RESISTANCE
$R_{th\ j-s}$	thermal resistance from junction to soldering point	up to $T_s = 140\text{ °C}$ (note 1)	50 K/W

Note

- T_s is the temperature at the soldering point of the collector tab.

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CHARACTERISTICS

$T_j = 25\text{ °C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CBO}	collector cut-off current	$I_E = 0; V_{CB} = 10\text{ V}$	–	–	100	nA
h_{FE}	DC current gain	$I_C = 30\text{ mA}; V_{CE} = 5\text{ V}$	45	90	–	
		$I_C = 45\text{ mA}; V_{CE} = 10\text{ V}$	–	100	–	
C_c	collector capacitance	$I_E = I_e = 0; V_{CB} = 10\text{ V}; f = 1\text{ MHz}$	–	0.9	2	pF
C_e	emitter capacitance	$I_C = I_e = 0; V_{EB} = 0.5\text{ V}; f = 1\text{ MHz}$	–	2.9	4.5	pF
C_{re}	feedback capacitance	$I_C = I_c = 0; V_{CE} = 10\text{ V}; f = 1\text{ MHz}$	–	0.5	0.8	pF
f_T	transition frequency	$I_C = 45\text{ mA}; V_{CE} = 10\text{ V}; f = 1\text{ GHz}; T_{amb} = 25\text{ °C}$	4	–	–	GHz
		$I_C = 30\text{ mA}; V_{CE} = 5\text{ V}; f = 1\text{ GHz}; T_{amb} = 25\text{ °C}$	4	6	–	GHz
G_{UM}	maximum unilateral power gain (note1)	$I_C = 45\text{ mA}; V_{CE} = 10\text{ V}; f = 1\text{ GHz}; T_{amb} = 25\text{ °C}$	11.5	13.5	–	dB
F	minimum noise figure	$\Gamma_s = \Gamma_{opt}; I_C = 45\text{ mA}; V_{CE} = 10\text{ V}; f = 500\text{ MHz}$	–	2.7	–	dB
		$\Gamma_s = \Gamma_{opt}; I_C = 45\text{ mA}; V_{CE} = 10\text{ V}; f = 1\text{ GHz}$	–	3	–	dB
V_O	output voltage	note 2	–	500	–	mV
d_2	second order intermodulation distortion	note 3	–	–51	–	dB
P_{L1}	output power at 1 dB gain compression	$I_C = 45\text{ mA}; V_{CE} = 10\text{ V}; R_L = 50\text{ }\Omega; T_{amb} = 25\text{ °C};$ measured at $f = 1\text{ GHz}$	–	21.5	–	dBm
ITO	third order intercept point	note 4	–	34	–	dBm

Notes

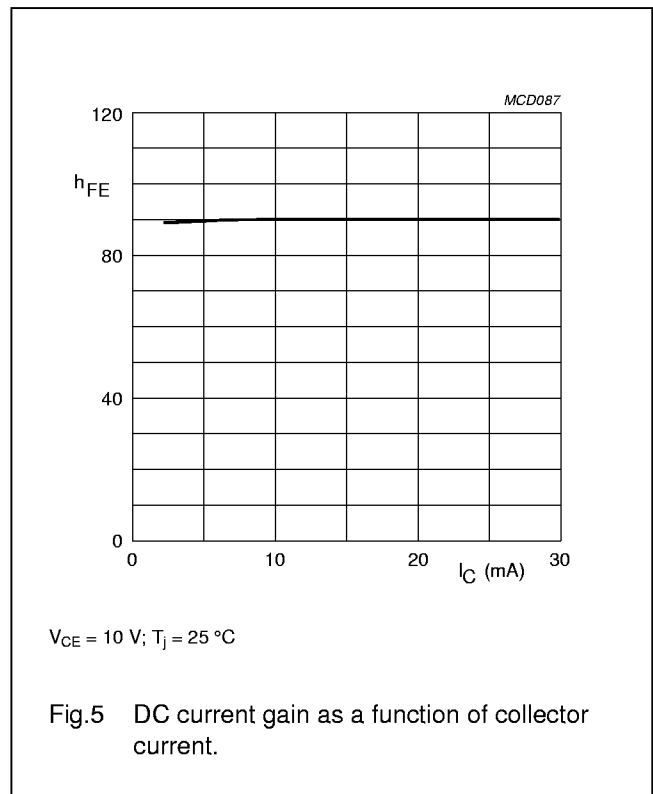
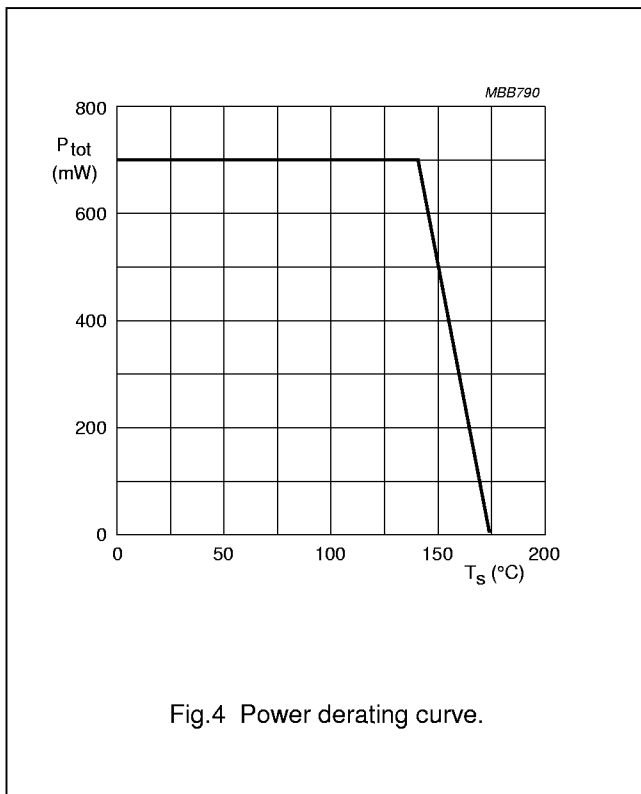
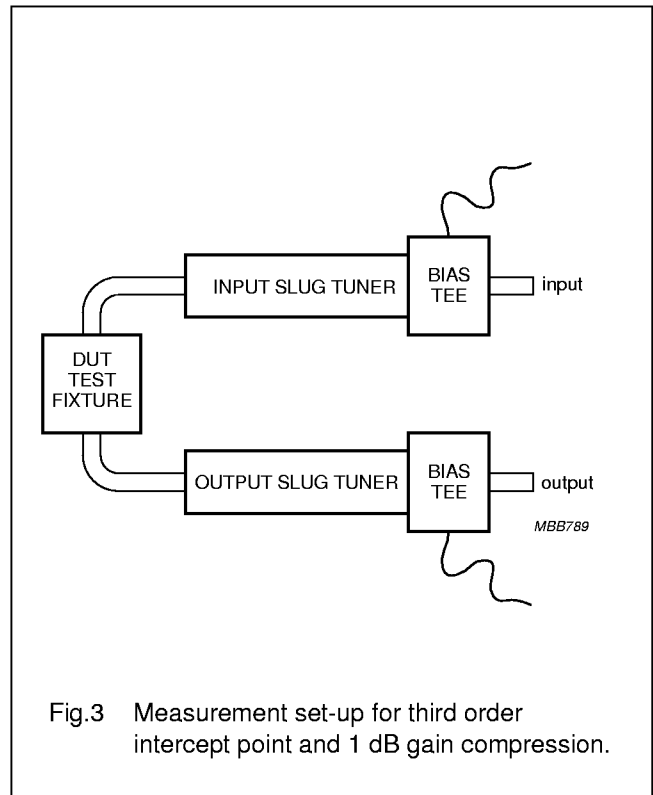
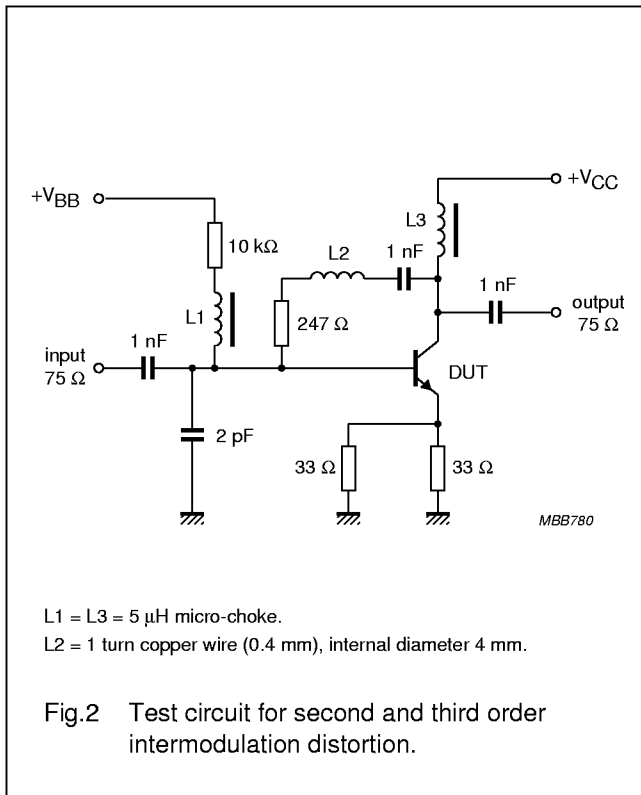
1. G_{UM} is the maximum unilateral power gain, assuming S_{12} is zero and

$$G_{UM} = 10 \log \left(\frac{|S_{21}|^2}{(1 - |S_{11}|^2)(1 - |S_{22}|^2)} \right) \text{dB.}$$

2. $d_{im} = -60\text{ dB}$ (DIN 45004B, par 6.3: 3-tone); $I_C = 45\text{ mA}; V_{CE} = 10\text{ V}; R_L = 75\text{ }\Omega; T_{amb} = 25\text{ °C};$
 $V_p = V_O$ at $d_{im} = -60\text{ dB}; f_p = 795.25\text{ MHz};$
 $V_q = V_O - 6\text{ dB}; V_r = V_O - 6\text{ dB};$
 $f_q = 803.25\text{ MHz}; f_r = 805.25\text{ MHz};$
 measured at $f_{(p+q-r)} = 793.25\text{ MHz}.$
3. $I_C = 45\text{ mA}; V_{CE} = 10\text{ V}; R_L = 75\text{ }\Omega; T_{amb} = 25\text{ °C};$
 $V_q = V_O = 280\text{ mV};$
 $f_p = 250\text{ MHz}; f_q = 560\text{ MHz};$
 measured at $f_{(p+q)} = 810\text{ MHz}.$
4. $I_C = 45\text{ mA}; V_{CE} = 10\text{ V}; R_L = 50\text{ }\Omega; T_{amb} = 25\text{ °C};$
 $f_p = 1000\text{ MHz}; f_q = 1001\text{ MHz};$
 measured at $f_{(2p-q)}$ and $f_{(2q-p)}.$

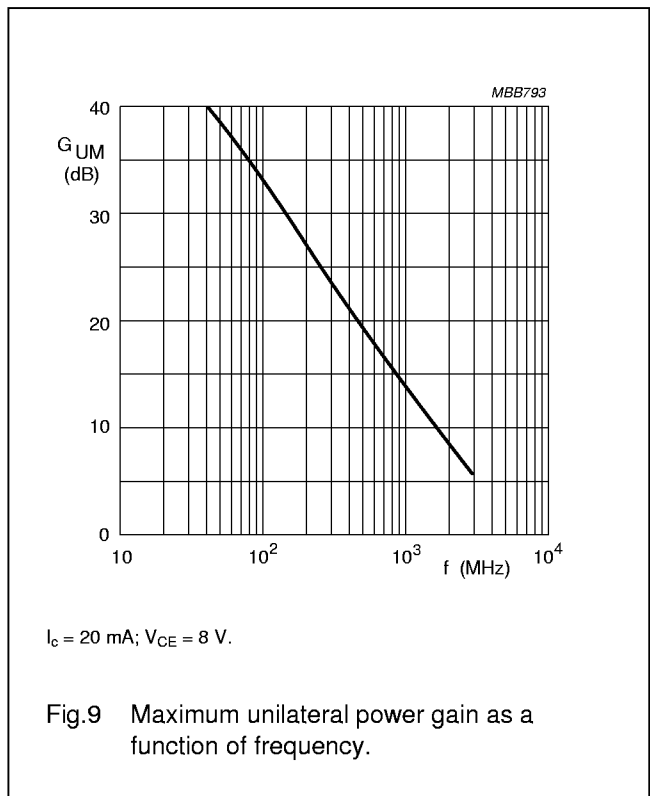
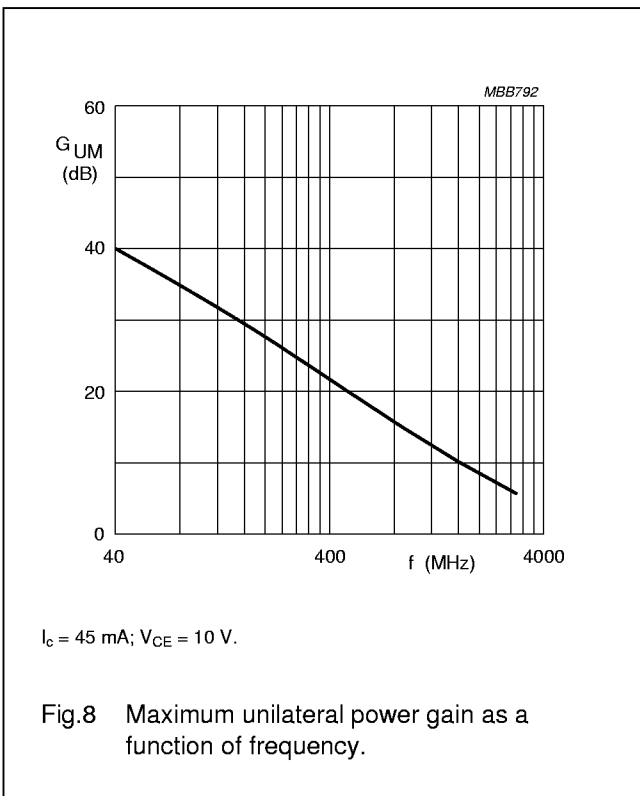
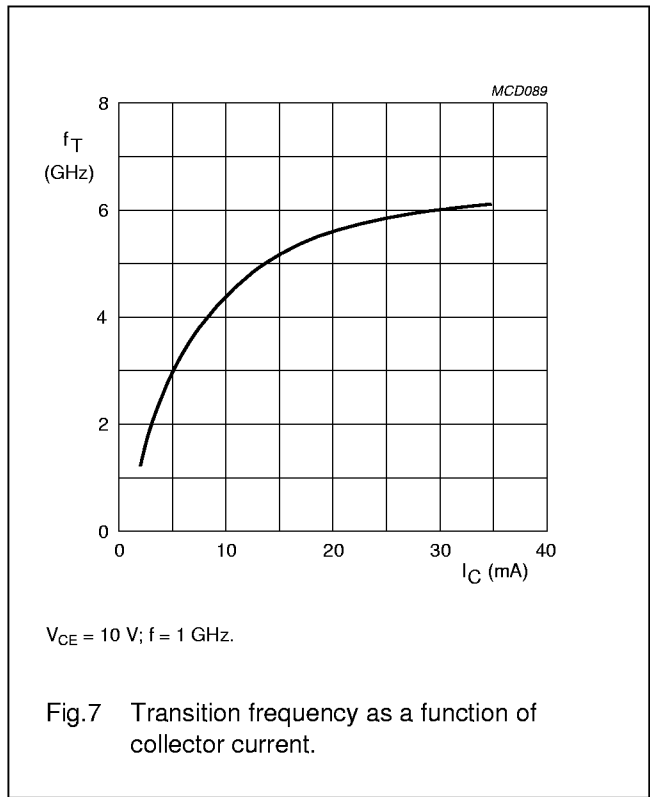
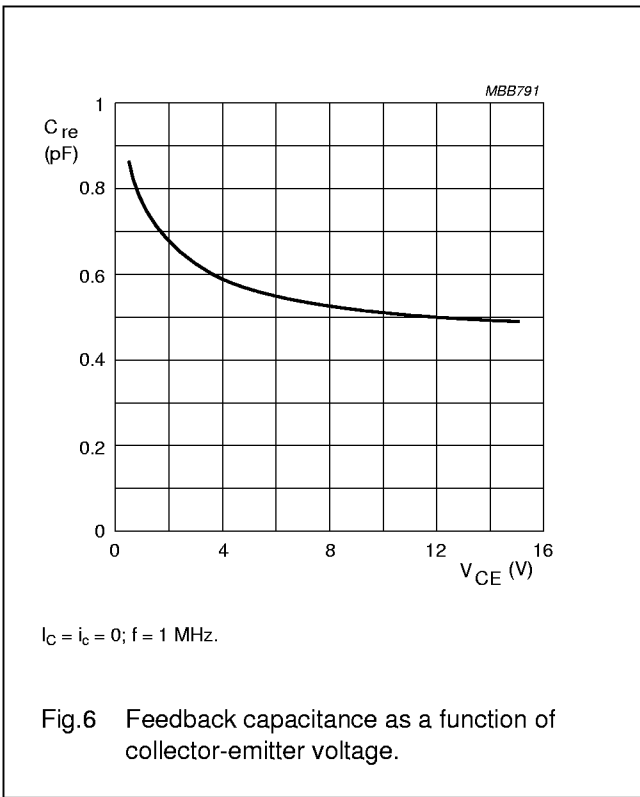
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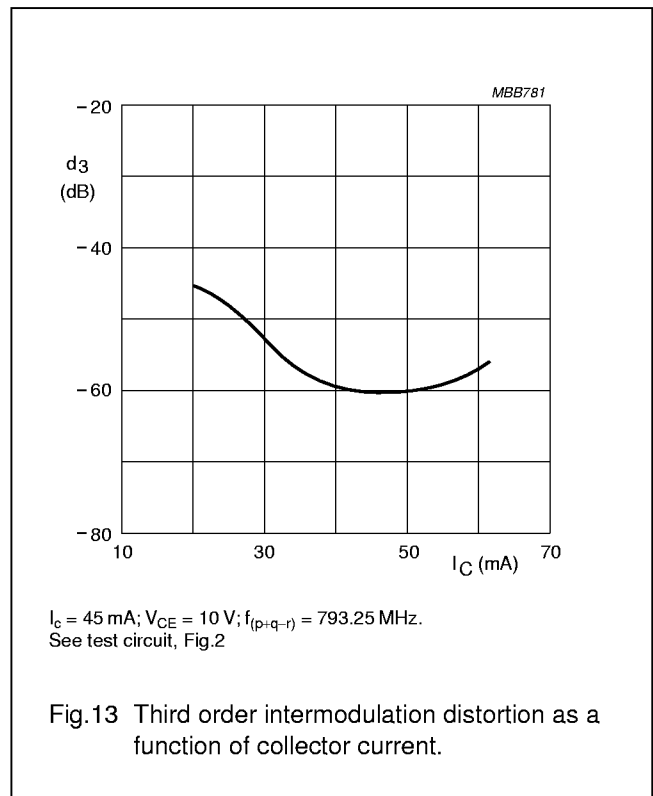
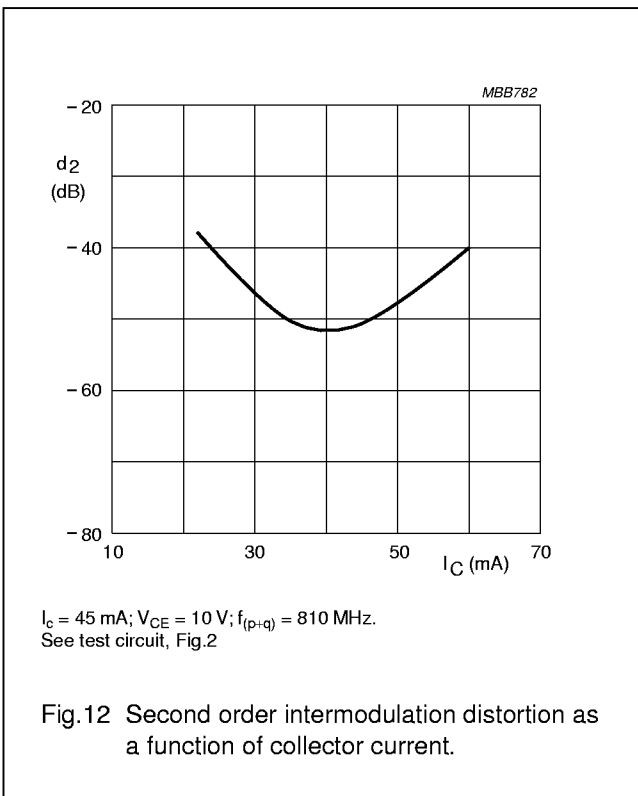
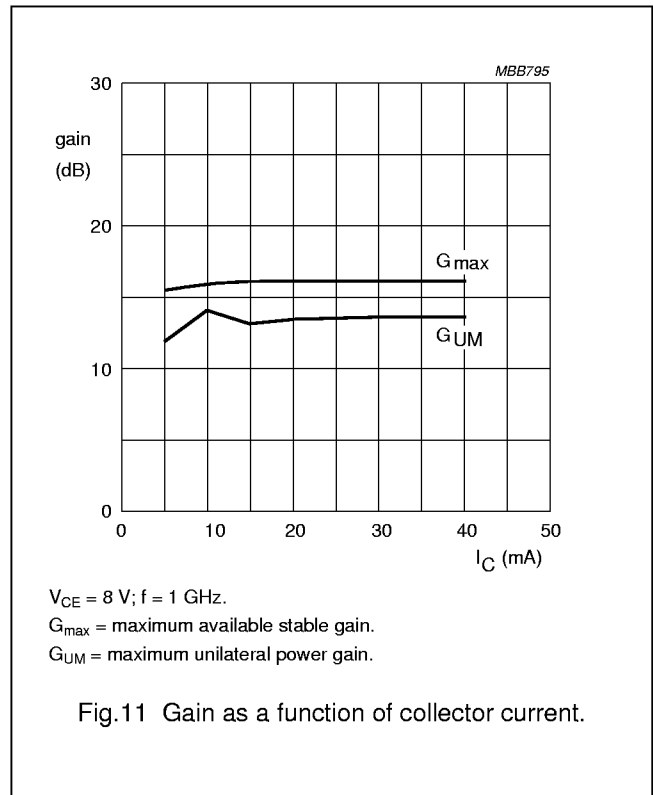
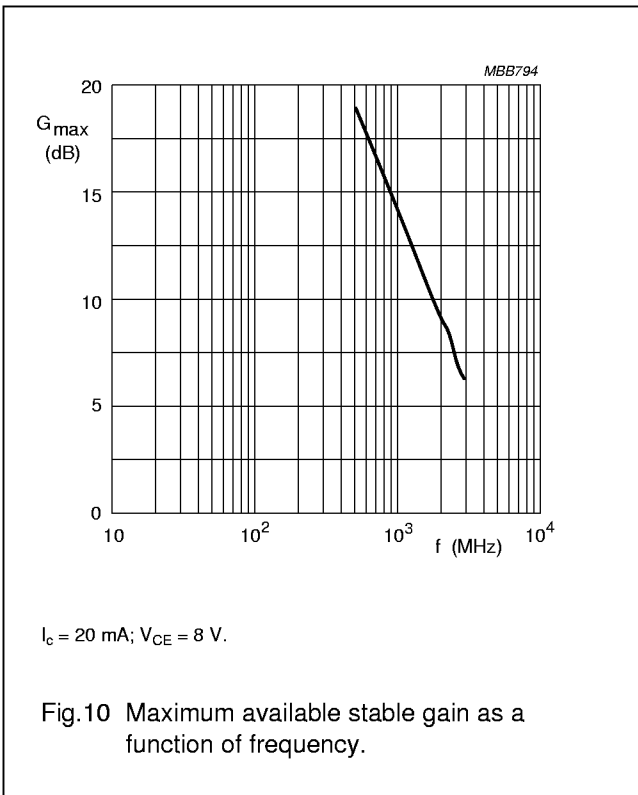
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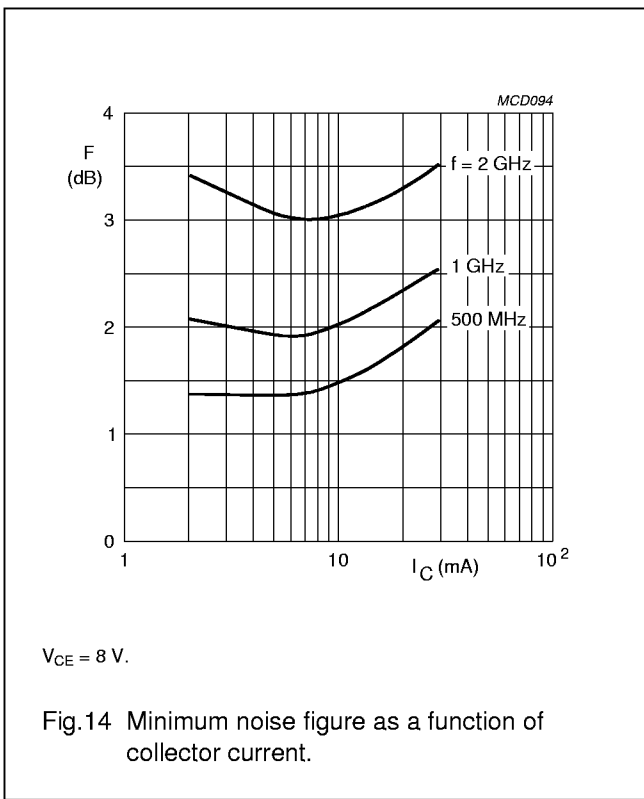
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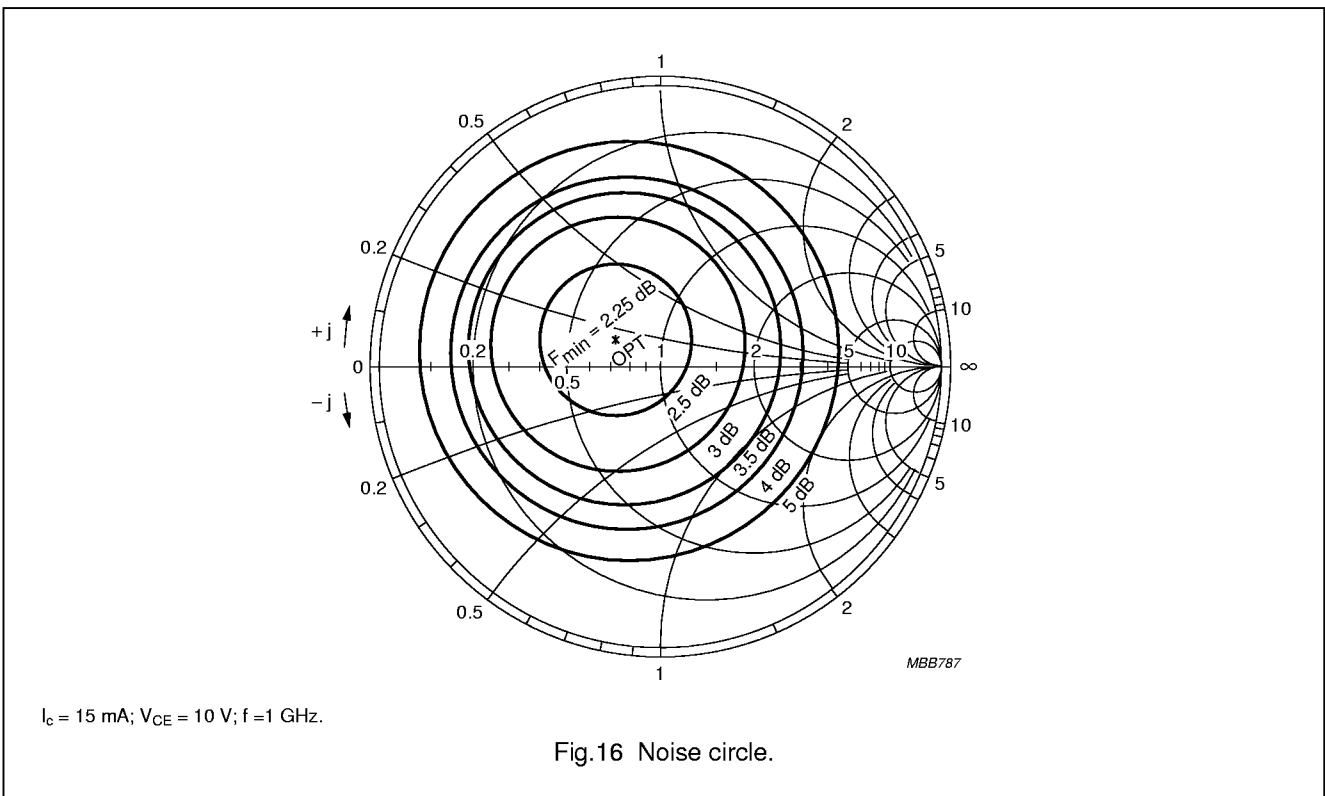
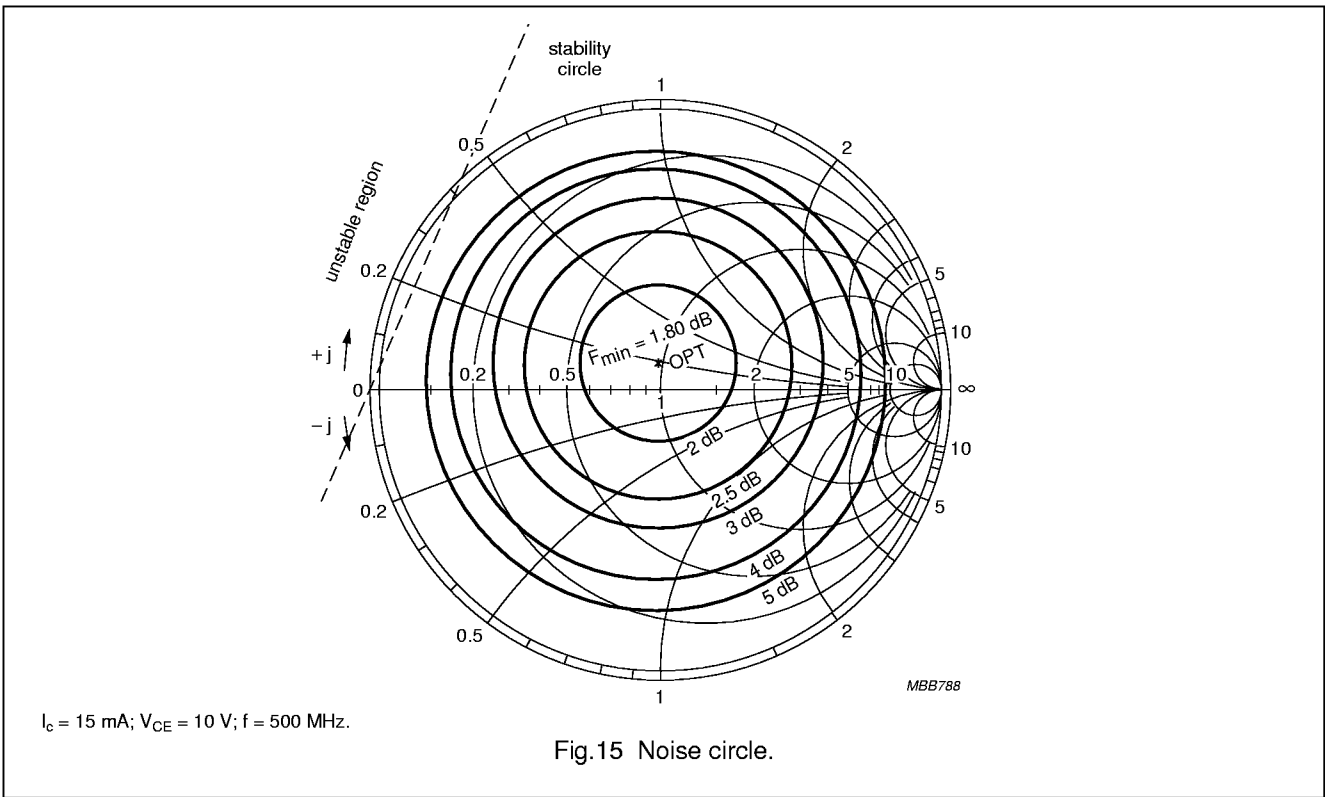
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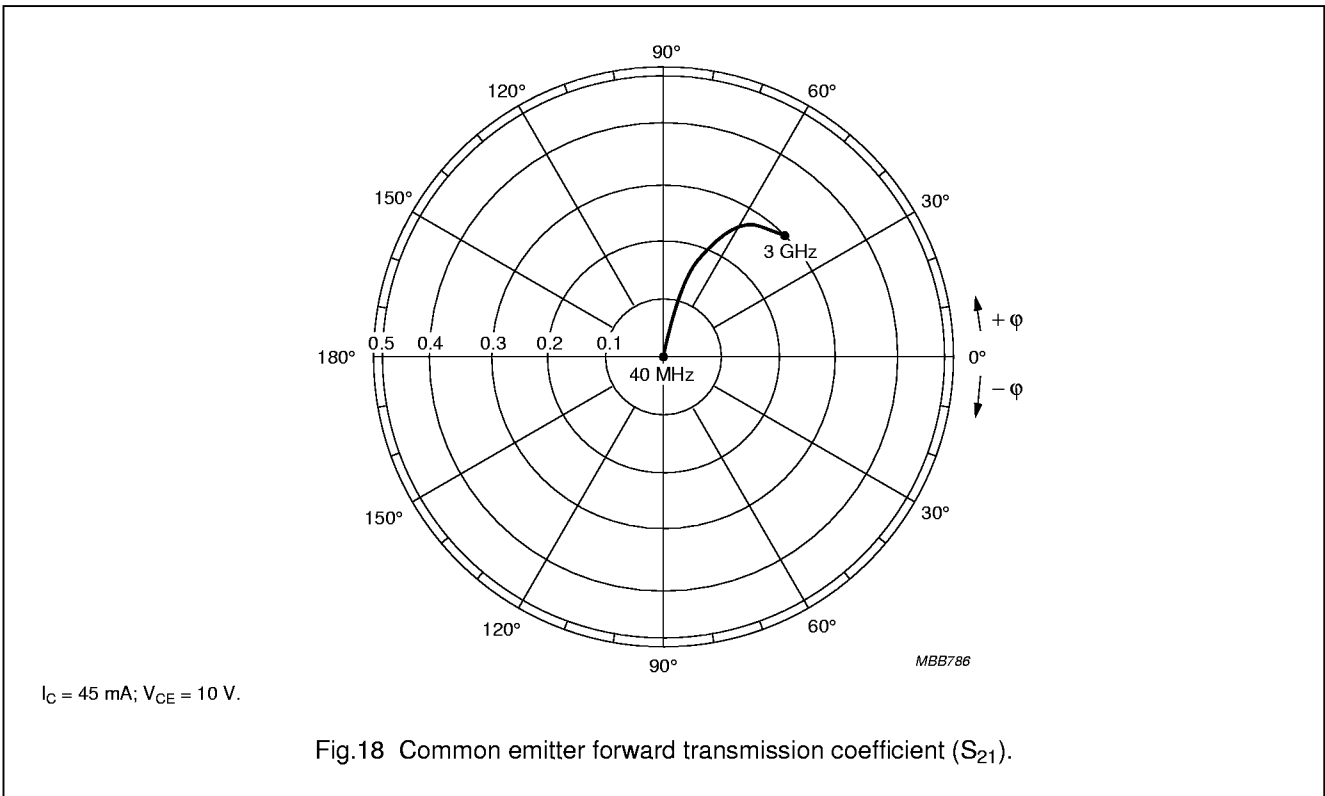
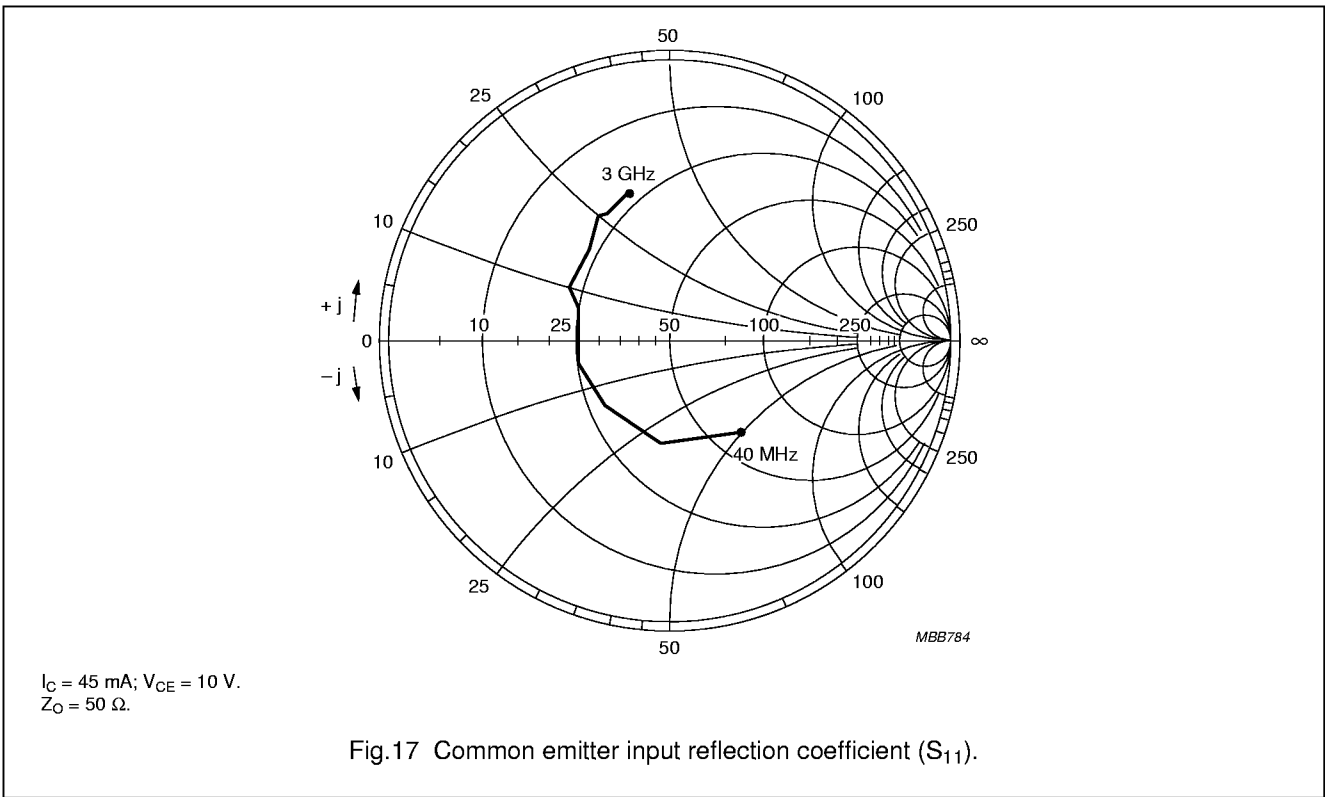
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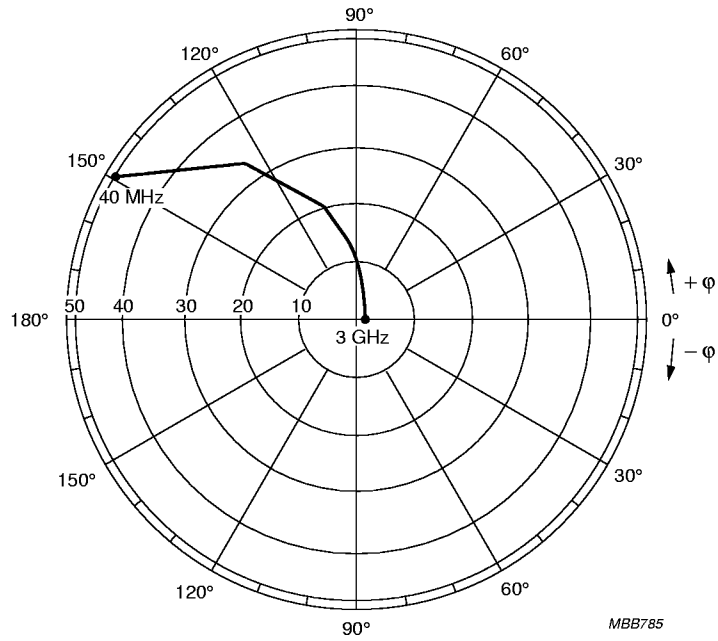
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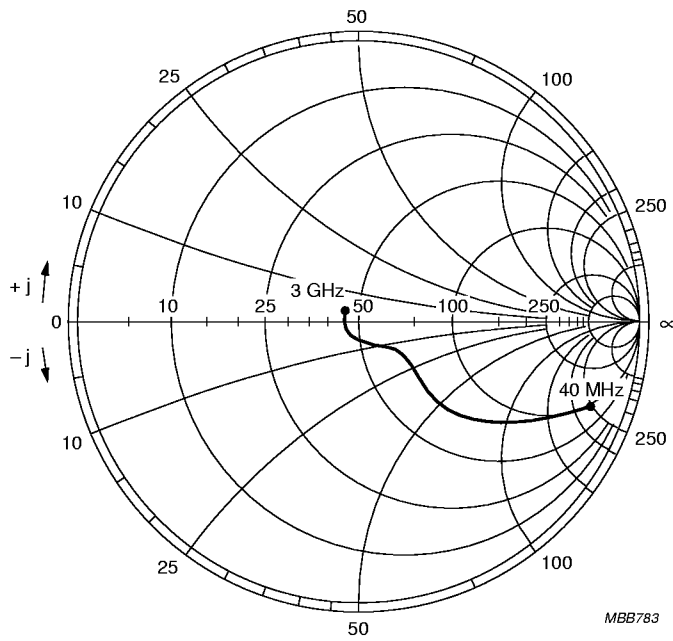
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$I_C = 45 \text{ mA}; V_{CE} = 10 \text{ V.}$

MBB785

Fig.19 Common emitter reverse transmission coefficient (S_{12}).



$I_C = 45 \text{ mA}; V_{CE} = 10 \text{ V.}$
 $Z_O = 50 \Omega.$

MBB783

Fig.20 Common emitter output reflection coefficient (S_{22}).

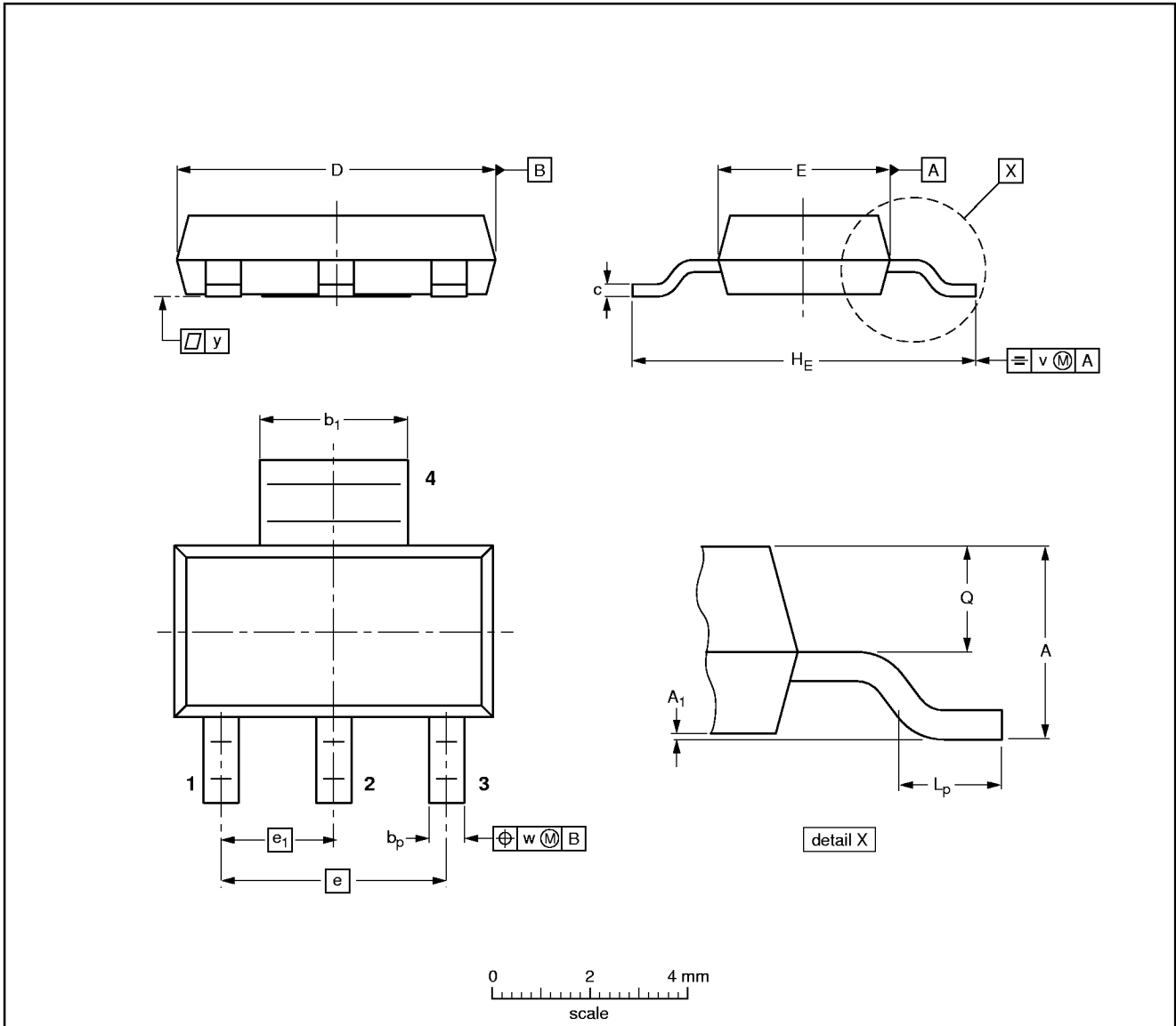
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PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 4 leads

SOT223



DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁	b _p	b ₁	c	D	E	e	e ₁	H _E	L _p	Q	v	w	y
mm	1.8 1.5	0.10 0.01	0.80 0.60	3.1 2.9	0.32 0.22	6.7 6.3	3.7 3.3	4.6	2.3	7.3 6.7	1.1 0.7	0.95 0.85	0.2	0.1	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT223						96-11-11 97-02-28